



SamHop Microelectronics Corp.



STK600

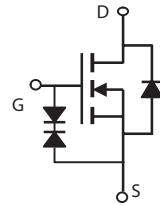
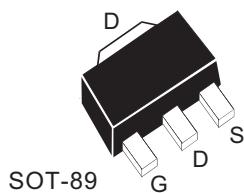
Ver 1.0

N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (Ω) Max
60V	0.8A	0.9 @ VGS=10V
		1.3 @ VGS=4.5V

FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- Surface Mount Package.
- ESD Protected.



ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current-Continuous ^a	0.80	A
		0.65	A
I_{DM}	-Pulsed ^b	4.4	A
E_{AS}	Single Pulse Avalanche Energy ^d	0.56	mJ
P_D	Maximum Power Dissipation	1.25	W
		0.8	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	100	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS ($T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	60			V
I _{DS}	Zero Gate Voltage Drain Current	V _{DS} =48V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±20V , V _{DS} =0V			±10	uA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	1.9	3	V
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V , I _D =0.40A		0.70	0.90	ohm
		V _{GS} =4.5V , I _D =0.34A		0.95	1.3	ohm
g _{FS}	Forward Transconductance	V _{DS} =10V , I _D =0.40A		0.9		S
DYNAMIC CHARACTERISTICS ^c						
C _{iss}	Input Capacitance	V _{DS} =25V,V _{GS} =0V f=1.0MHz		43		pF
C _{oss}	Output Capacitance			17		pF
C _{rss}	Reverse Transfer Capacitance			8.8		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =30V I _D =0.40A V _{GS} =10V R _{GEN} = 6 ohm		6.3		ns
t _r	Rise Time			8.6		ns
t _{D(OFF)}	Turn-Off Delay Time			42		ns
t _f	Fall Time			11		ns
Q _g	Total Gate Charge	V _{DS} =30V,I _D =0.40A,V _{GS} =10V		1.56		nC
		V _{DS} =30V,I _D =0.40A,V _{GS} =4.5V		1.1		nC
Q _{gs}	Gate-Source Charge	V _{DS} =30V,I _D =0.40A, V _{GS} =10V		0.36		nC
Q _{gd}	Gate-Drain Charge			0.61		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	V _{GS} =0V,I _s =0.1A		0.81	1.3	V
Notes						
a.Surface Mounted on FR4 Board,t ≤ 10sec.						
b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.						
c.Guaranteed by design, not subject to production testing.						
d.Starting T _J =25°C,L=0.5mH,V _{DD} = 30V.(See Figure13)						

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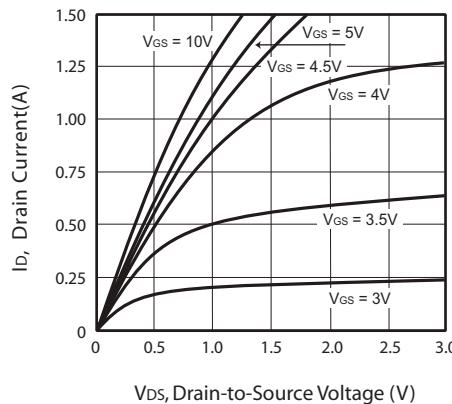


Figure 1. Output Characteristics

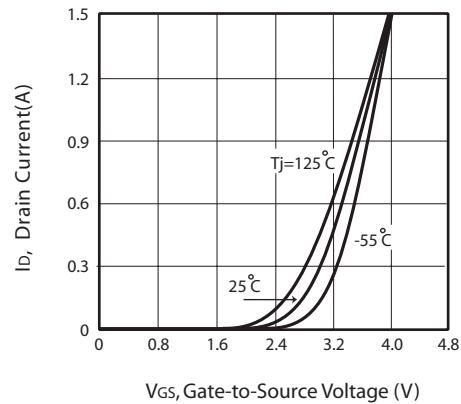


Figure 2. Transfer Characteristics

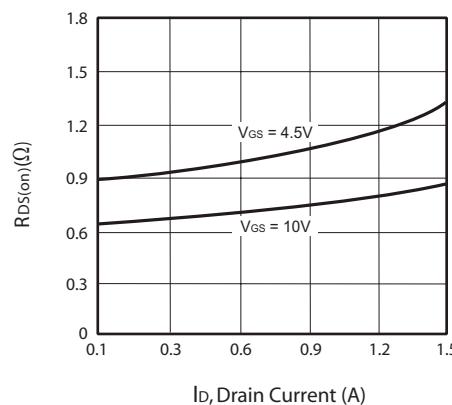


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

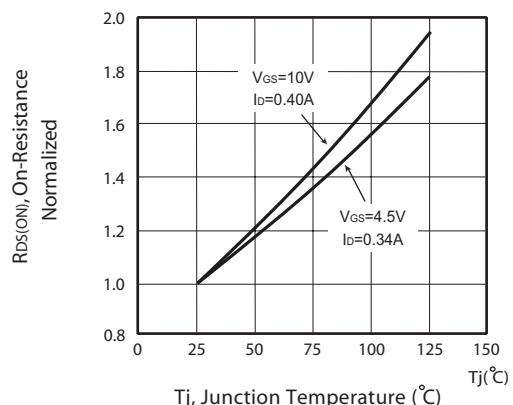


Figure 4. On-Resistance Variation with Drain Current and Temperature

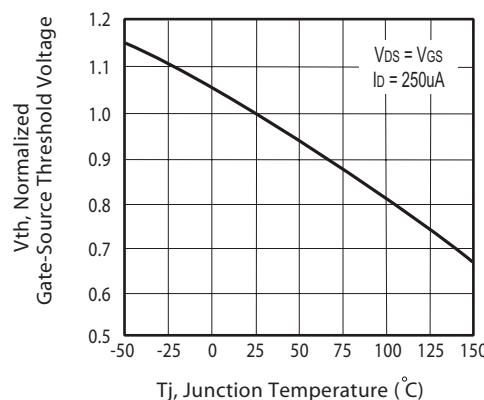


Figure 5. Gate Threshold Variation with Temperature

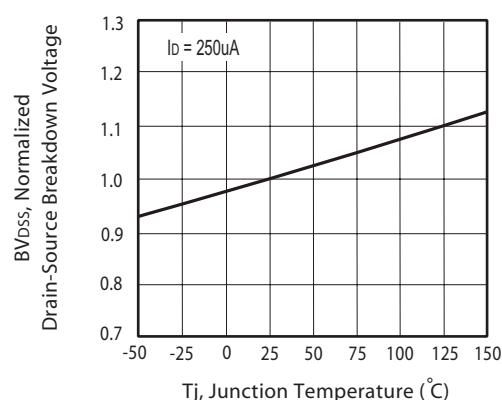


Figure 6. Breakdown Voltage Variation with Temperature

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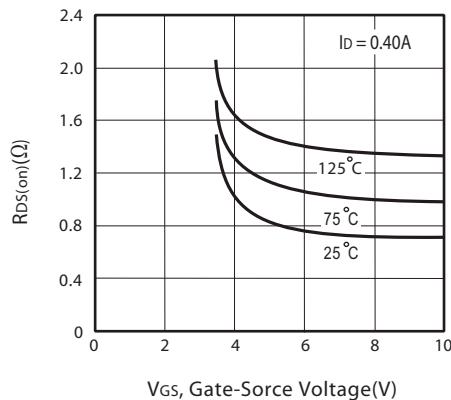


Figure 7. On-Resistance vs.
Gate-Source Voltage

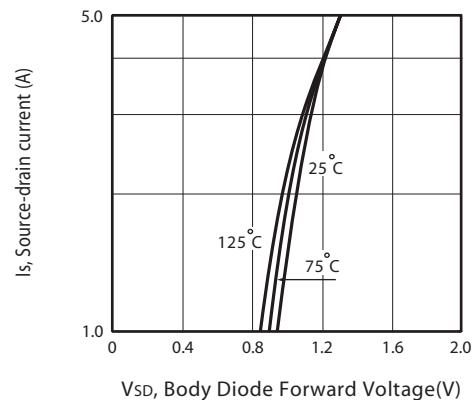
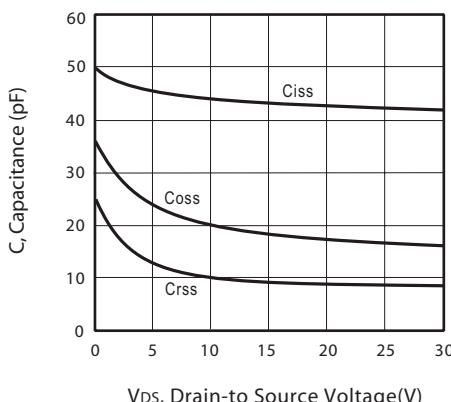


Figure 8. Body Diode Forward Voltage
Variation with Source Current



V_{DS}, Drain-to Source Voltage(V)

Figure 9. Capacitance

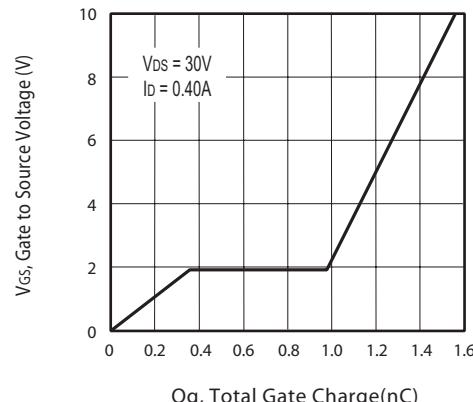
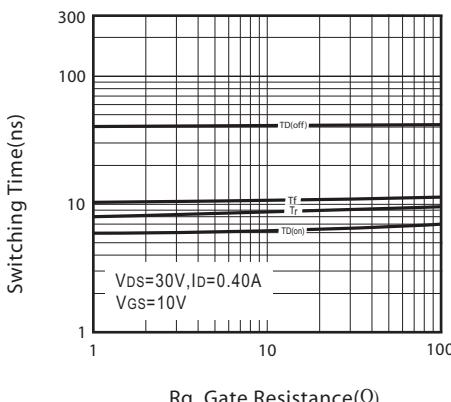
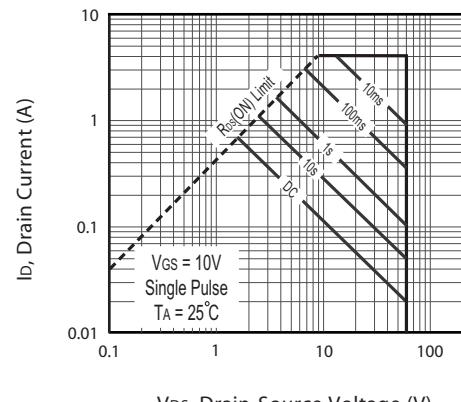


Figure 10. Gate Charge



R_g, Gate Resistance(Ω)

Figure 11. switching characteristics

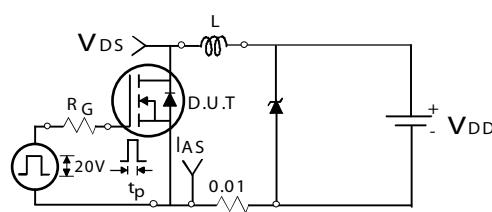


V_{DS}, Drain-Source Voltage (V)

Figure 12. Maximum Safe
Operating Area

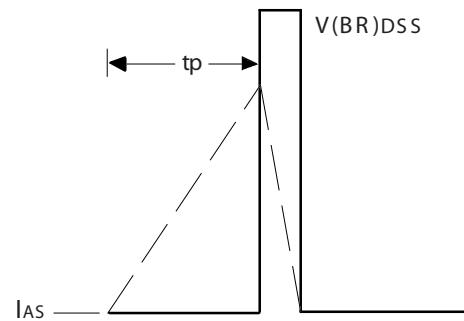
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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

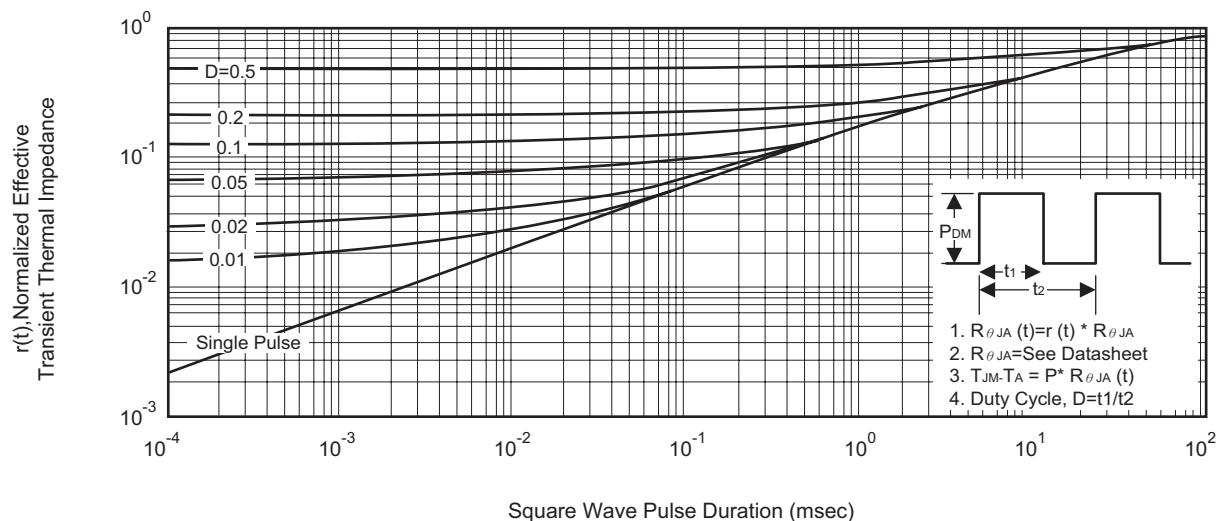
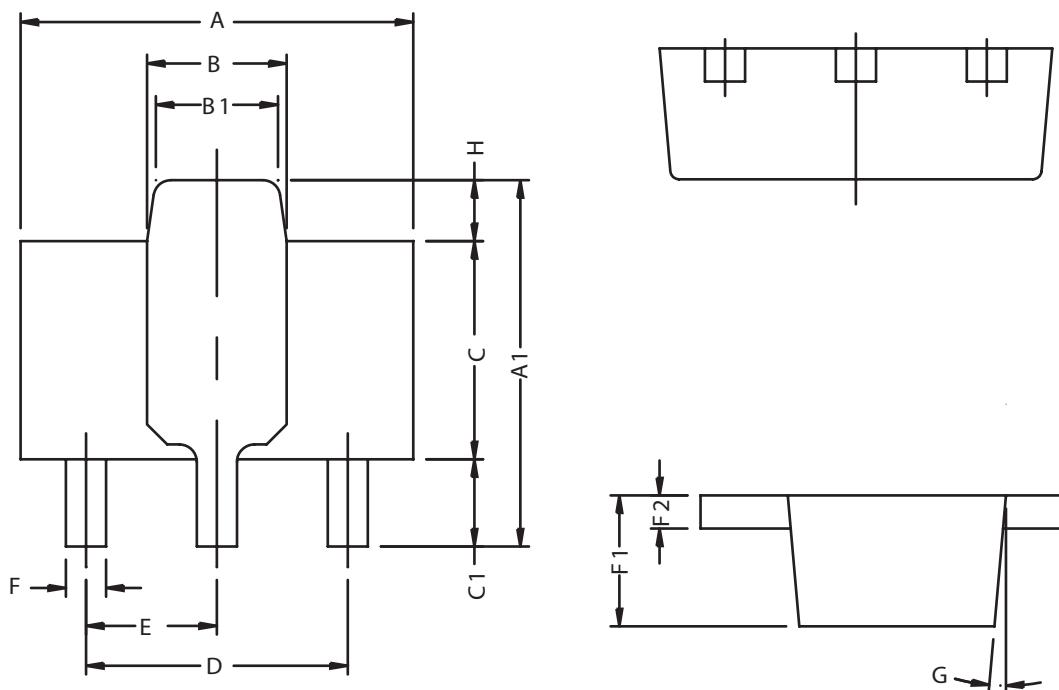


Figure 14. Normalized Thermal Transient Impedance Curve

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PACKAGE OUTLINE DIMENSIONS

SOT-89



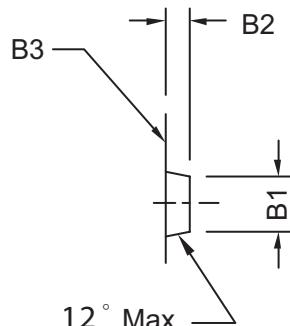
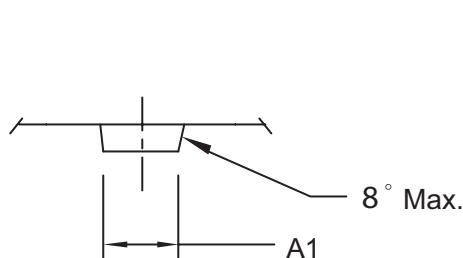
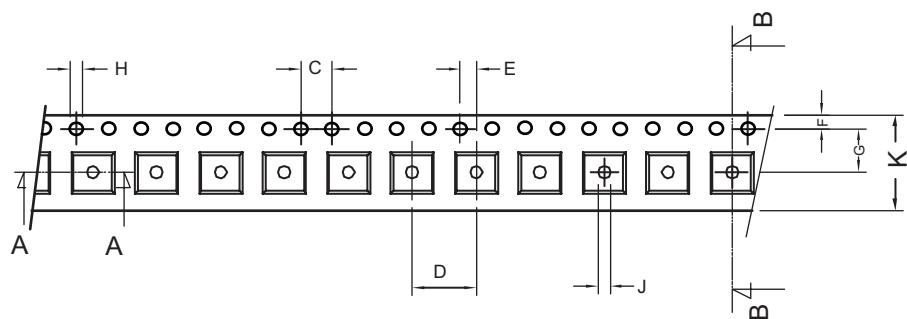
REF.	DIMENSIONS	
	Milimeters	
	MIN.	MAX.
A	4.40	4.60
A1	4.05	4.25
B	1.50	1.70
B1	1.30	1.50
C	2.40	2.60
C1	0.89	1.20
D	3.00	REF.
E	1.50	REF.
F	0.40	0.52
F1	1.40	1.60
F2	0.35	0.41
G	5°	TYP.
H	0.70	REF.

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SOT-89 Tape

SOT-89 Carrier Tape



unit:mm

PACKAGE	A1	B1	B2	C	D	E	B3	F	G	H	J	K	10C
SOP 8N 150mil	4.85 ±0.10	4.45 ±0.10	1.85 ±0.10	4.0 ±0.10	8.0 ±0.10	2.0 ±0.05	0.254 ±0.02	1.75 ±0.10	5.5 ±0.05	1.50 ±0.10	1.5 ±0.25	12.0 +0.30 -0.10	40.0 ±0.20

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